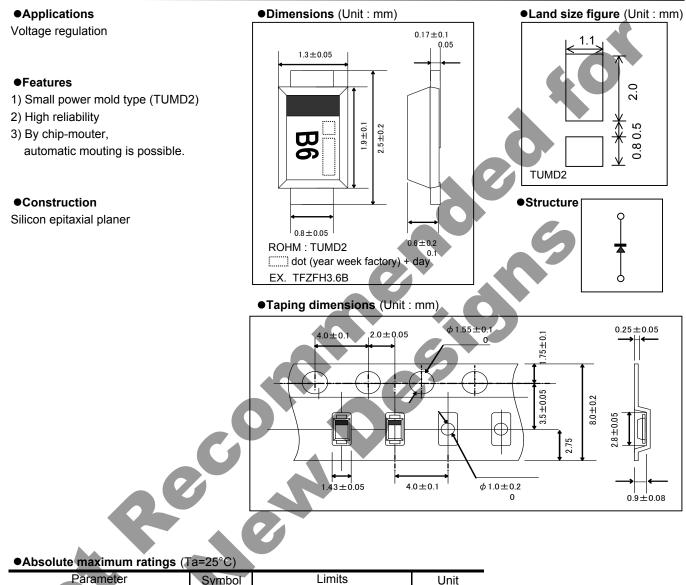


AEC-Q101 Qualified

Zener diode **TFZFH** series



Absolute	max	imum	ratings	(]	a=2	5°C)	

Parameter	Symbol	Limits	Unit
Power dissipation	P	500	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C
Operating resistance	Topr	–55 to +150	°C

•Electical characteristics (Ta=25°C)

				Symbol				
	Zener Voltage : Vz(V)					Reverse		
TYP.	∠ene	r voltage :	VZ(V)	V) Dynamic Impedance : $Z_{Z}(\Omega)$ Current : $I_{R}(\mu A)$		Current:I _R (μA)		
	MIN.	MAX.	lz(mA)	MAX.	lz(mA)	MAX.	V _R (V)	
TFZFH3.6B	3.600	3.845	20	60	20	10	1.0	
TFZFH3.9B	3.890	4.160	20	50	20	5	1.0	
TFZFH4.3B	4.170	4.430	20	40	20	5	1.0	
TFZFH4.7B	4.550	4.800	20	25	20	5	1.0	
TFZFH5.1B	4.940	5.200	20	20	20	5	1.5	
TFZFH5.6B	5.450	5.730	20	13	20	5	2.5	
TFZFH6.2B	5.960	6.270	20	10	20	5	3.0	
TFZFH6.8B	6.490	6.830	20	8	20	2	3.5	
TFZFH7.5B	7.070	7.450	20	8	20	0.5	4.0	
TFZFH8.2B	7.780	8.190	20	8	20	0.5	5.0	
TFZFH9.1B	8.570	9.010	20	8	20	0.5	6.0	
TFZFH10B	9.410	9.900	20	8	20	0.2	7.0	
TFZFH11B	10.500	11.050	10	10	10	0.2	8.0	
TFZFH12B	11.440	12.030	10	12	10	0.2	9.0	
TFZFH13B	12.550	13.210	10	14	10	0.2	10	
TFZFH15B	13.890	14.620	10	16	10	0.2	11	60
TFZFH16B	15.250	16.040	10	18	10	0.2	12	
TFZFH18B	16.820	17.700	10	23	10	0.2	13	
TFZFH20B	18.630	19.590	10	28	10	0.2	15	
TFZFH22B	20.640	21.710	5	30	5	0.2	17	
TFZFH24B	22.610	23.770	5	35	5	0.2	19	
TFZFH27B	24.970	26.260	5	45	5	0.2	21	
TFZFH30B	27.700	29.130	5	55	5	0.2	23	*
TFZFH33B	30.320	31.880	5	65	5	0.2	25	
TFZFH36B	32.790	34.490	5	75	5	0.2	27	
TFZFH39B	35.360	37.190	5	85	5	0.2	30	

(1) The zener voltage(Vz) is measured 40ms after power is supplied.

B I B J

ΒK

ΒL

(2) The operating resistances(Zz,Zzk) are measured by superimposing a minute alternating current on the regulated current(Iz)

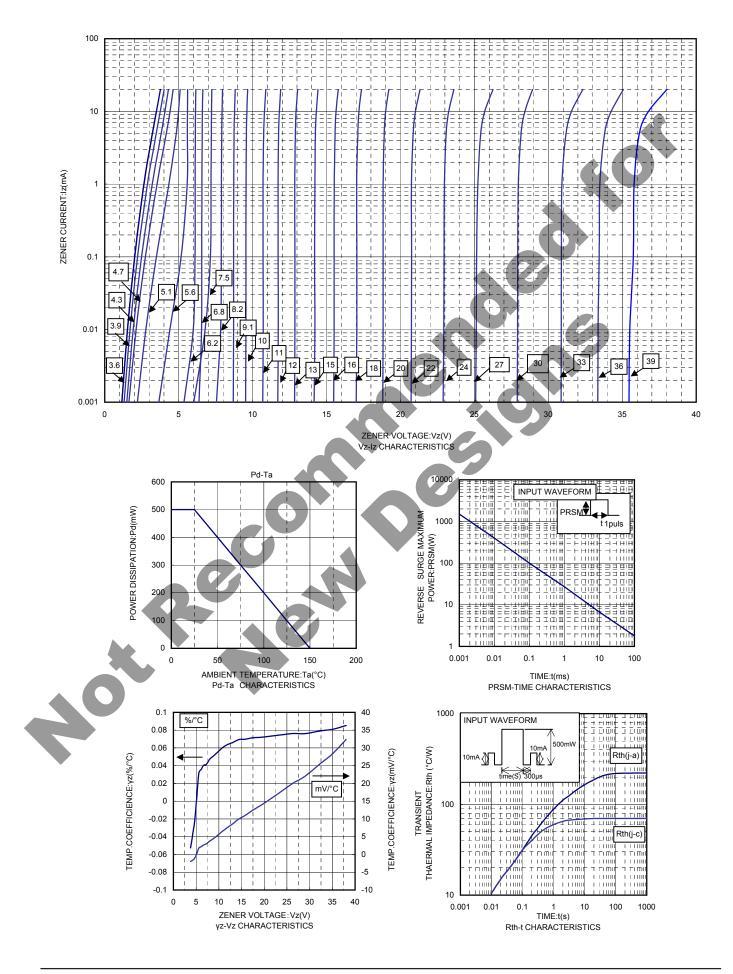
•MARKING (TYPE NO.)

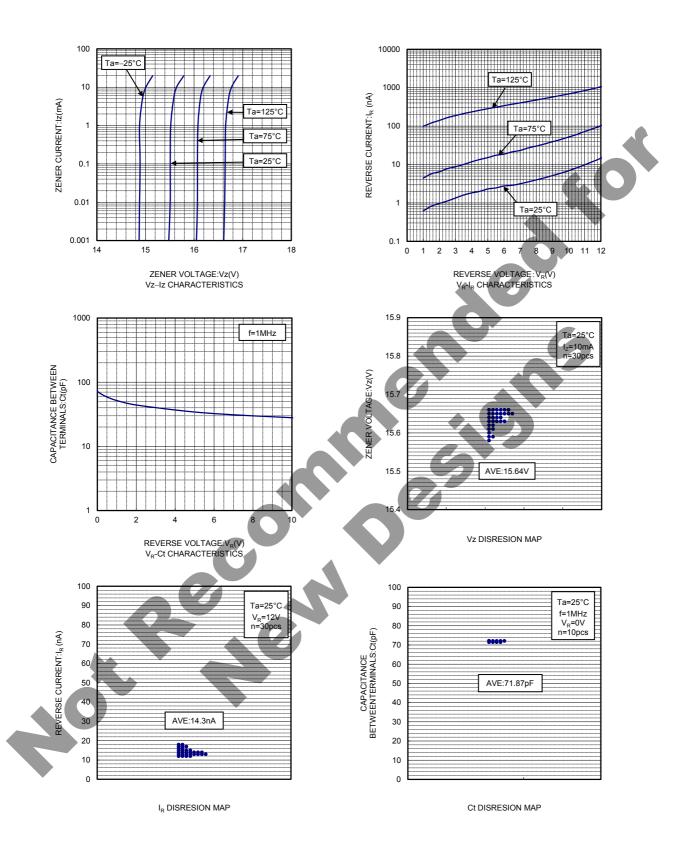
TFZFH11B

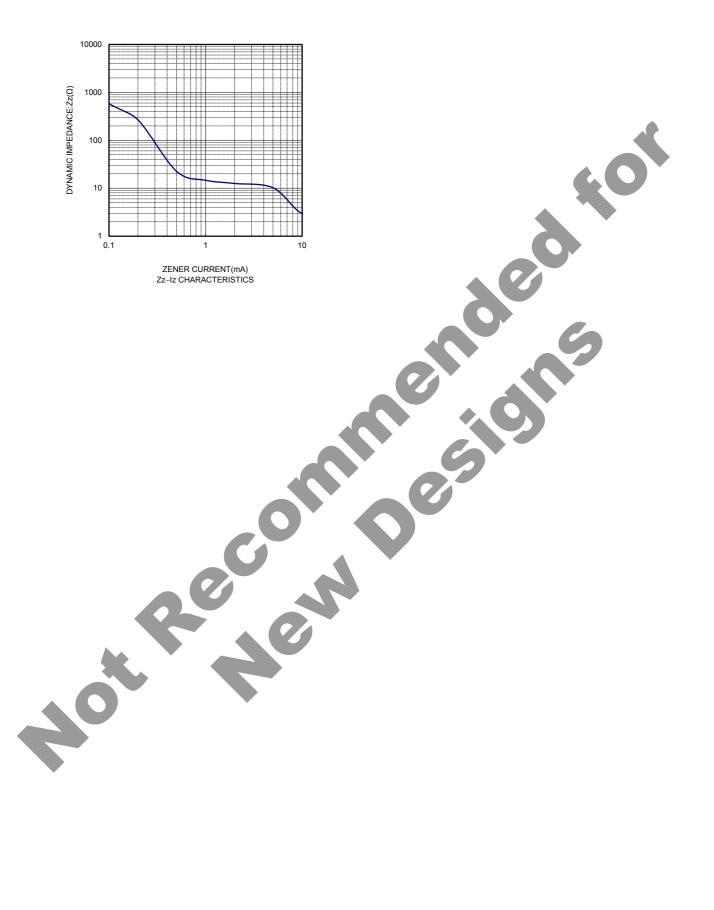
TFZFH12B TFZFH13B

TFZFH15B

TYPE	TYPE NO.	TYPE	TYPE NO.
TFZFH3.6B	B 6	TFZFH16B	ВM
TFZFH3.9B	B 7	TFZFH18B	ΒN
TFZFH4.3B	B 8	TFZFH20B	ВО
TFZFH4.7B	B 9	TFZFH22B	ΒP
TFZFH5.1B	ВА	TFZFH24B	ΒQ
TFZFH5.6B	B B	TFZFH27B	ΒR
TFZFH6.2B	ВC	TFZFH30B	ΒS
TFZFH6.8B	ВD	TFZFH33B	ΒT
TFZFH7.5B	ΒE	TFZFH36B	ВU
TFZFH8.2B	ΒF	TFZFH39B	ΒV
TFZFH9.1B	ВG		
TFZFH10B	ΒH		







Notice

Precaution on using ROHM Products

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1)) Medical	Equip	oment	Classifie	cation	of the	Spec	ific Ap	oplication	S

JAPAN	USA	EU	CHINA	
CLASSⅢ		CLASS II b		
CLASSIV	CLASSⅢ	CLASSⅢ	- CLASSⅢ	

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:

[a] Installation of protection circuits or other protective devices to improve system safety

[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc. prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.

Confirm that operation temperature is within the specified range described in the product specification.

ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

8.

9

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

Precaution Regarding Intellectual Property Rights

- All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data.
- 2. ROHM shall not have any obligations where the claims, actions or demands arising from the combination of the Products with other articles such as components, circuits, systems or external equipment (including software).

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General Precaution

- 1. Before you use our Products, you are requested to care fully read this document and fully understand its contents. ROHM shall not be in an y way responsible or liable for failure, malfunction or accident arising from the use of a ny ROHM's Products against warning, caution or note contained in this document.
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